



	Material	Thickness
Overlay		
Solder	SM-001	1.00mil
Surface Finish	PbSn	0.79mil
Cer	CF-004	1.38mil
ic 1	Core-043	59.00mil
Layer	CF-004	1.38mil
Surface Finish	PbSn	0.79mil
Solder	SM-001	1.00mil
Overlay		

**ckness:**

Page 1

Hole Size	Plated	Hole Type	Drill Layer Pair	Via/Pad	Pad Shape
0.300mm (11.81mil)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded
0.500mm (19.69mil)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded
1.100mm (43.31mil)	PTH	Round	Top Layer - Bottom Layer	Pad	(Mixed)
3.200mm (125.98mil)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded